

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0				

NOTES:

1) MATERIAL:

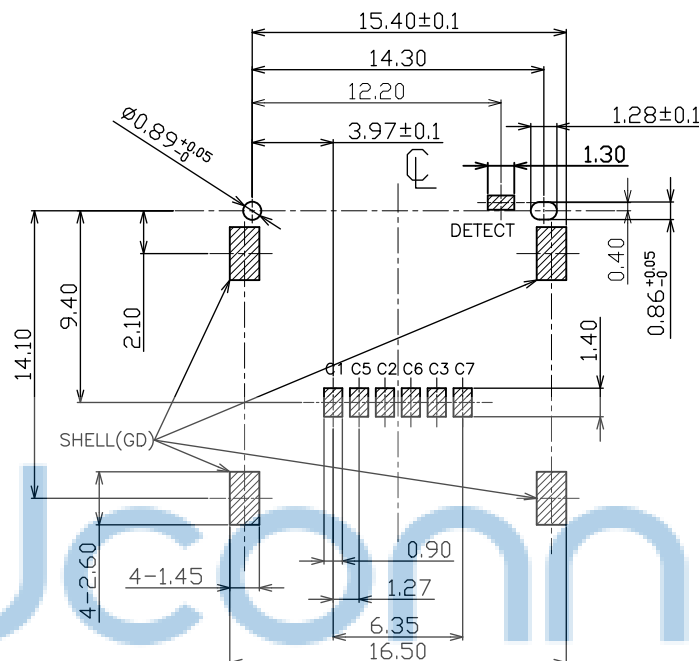
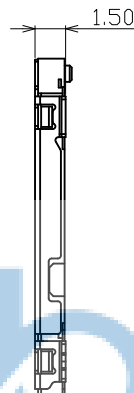
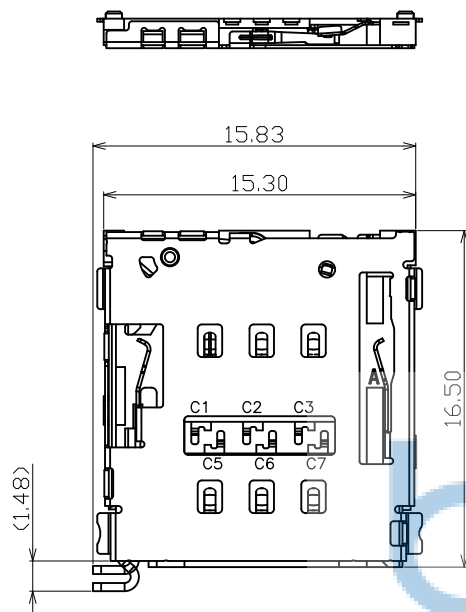
- 1-1 HOUSING: THERMOPLASTIC, UL 94V-0; COLOR: BLACK
- 1-2 SHIELDED: STAINLESS STEEL
- 1-3 CONTACT: COPPER ALLOY
- 1-4 SWITCH PIN: COPPER ALLOY

2) FINISH:

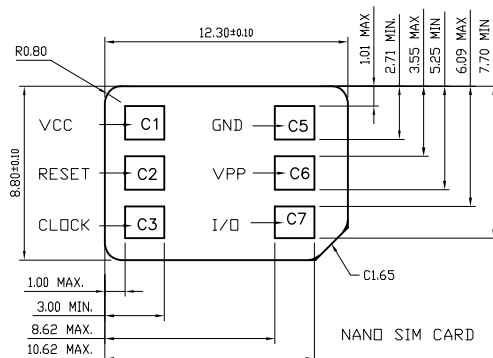
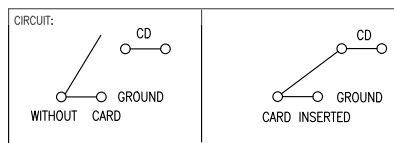
- 2-1 CONTACT: Au PLATING ON CONTACT AREA
(SEE P/N DESCRIPTION)
50u" MIN NICKEL UNDERPLATING OVER ALL
1u" MIN AU PLATING ON SOLD AREA,
- 2-2 SHIELDED: 1u" MIN Au PLATING ON SECURED AREA

3) PRODUCT SPECIFICATIONS:

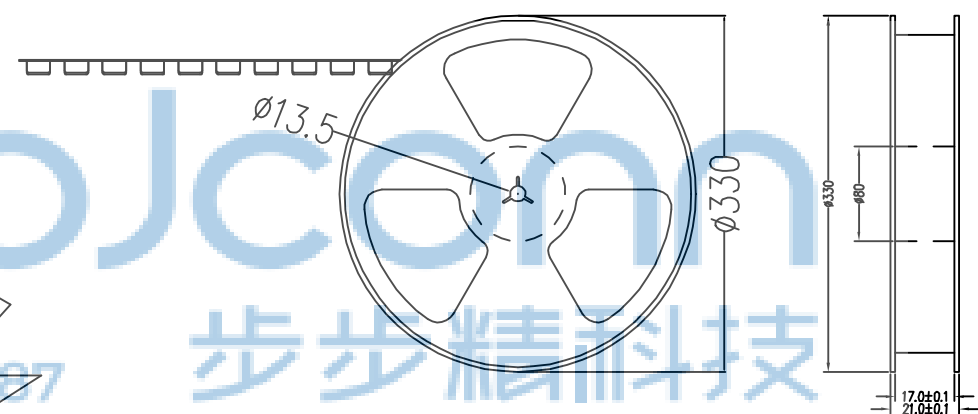
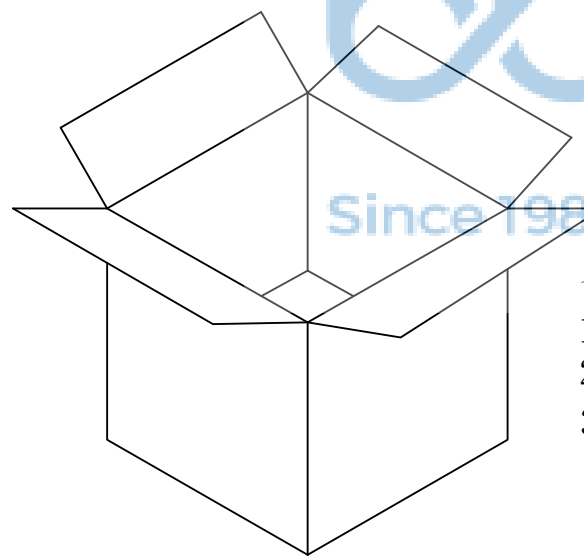
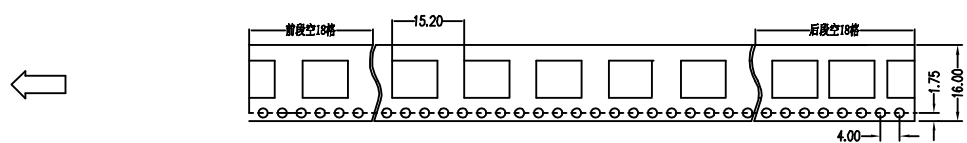
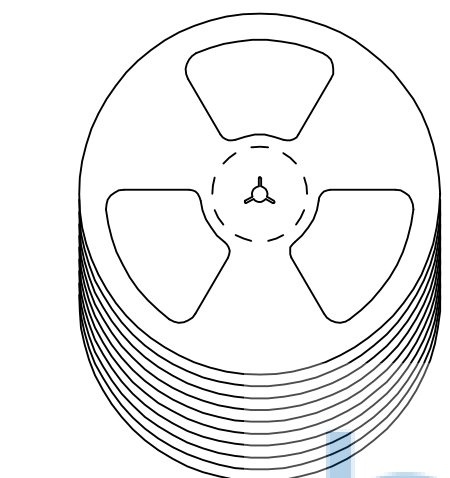
- 3-1 VOLTAGE RATING: 50V
- 3-2 WITHSTANDING VOLTAGE: AC250V R.M.S
- 3-3 CURRENT RATING: 0.5A
- 3-4 INSULATION RESISTANCE: 1000MEG.OHM MIN AT DC 250V
- 3-5 CONTACT RESISTANCE: 100 MILL.OHM MAX
- 3-6 OPERATION TEMPERATURE: -20° TO +85°



RECOMMENDED PC BOARD LAYOUT
TOLERANCE: ±0.05(TOP VIEW)



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Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		NAME: 卡座 NANO SIM 1.5H 6PIN 带SMT检测P (228-SIM06-150)	
PDWG.NO: 0214-1		APPD. JM_Zheng	
		CHKD. LYX	
		DR. TSP	
		PJ. NO.: CD.02.02-02-0015	
		SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/2	



- 备注:
1. 包装数量: 1000/PCS/卷, 10卷/箱。
 2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
 3. 材质:
载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM
纸箱规格: 345*345*35MM

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.X: ± 0.38 .XX: ± 0.25 .XXX: ± 0.13	X': $\pm 3'$.X': $\pm 2'$.XX': $\pm 1'$	NAME: 卡座 NANO SIM 1.5H 6PIN 带SMT检测P (228-SIM06-150)	
APPD.	JM_Zheng	PJ. NO.: CD.02.02-02-0015	
CHKD.	LYX	SIZE: A4 DRW NO.:	
DR.		TSP	FINISH: SEE NOTES SCALE: N/A REV.: A0 UNIT: mm PAGE: 2/2
		MAT'L.: SEE NOTES	